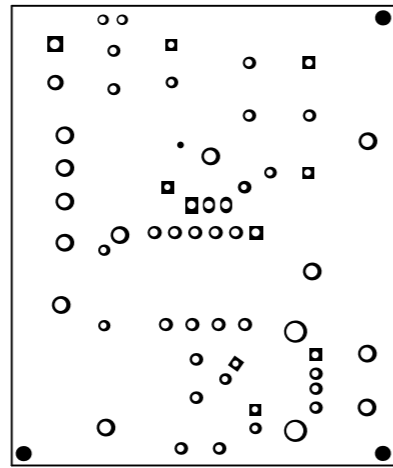
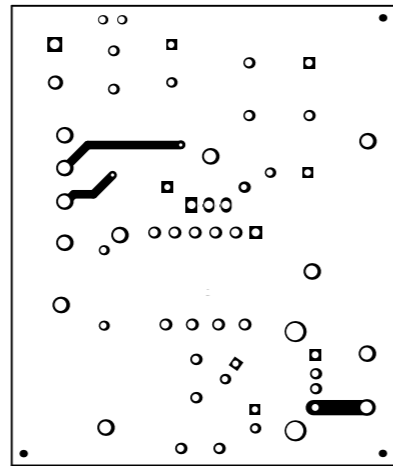


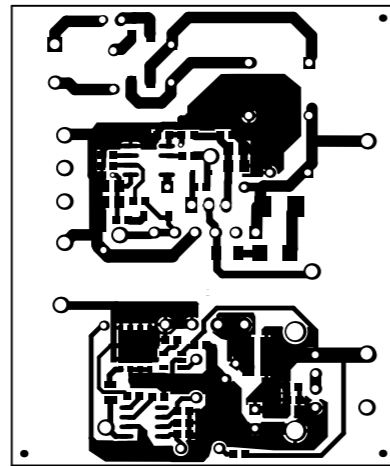
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/2/2015 3:35:43 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/2/2015 3:35:44 PM	TEXAS INSTRUMENTS	



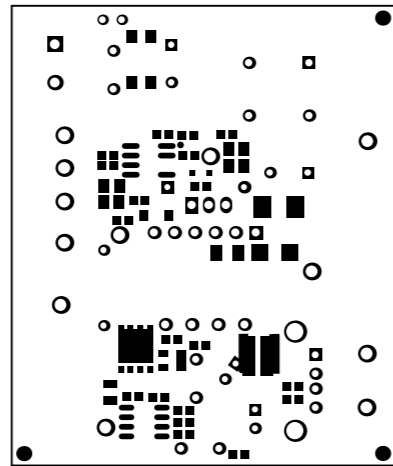
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/2/2015 3:35:45 PM	TEXAS INSTRUMENTS	



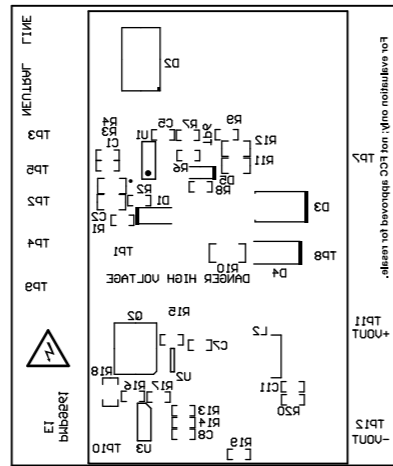
:SUN

Not In VersionControl

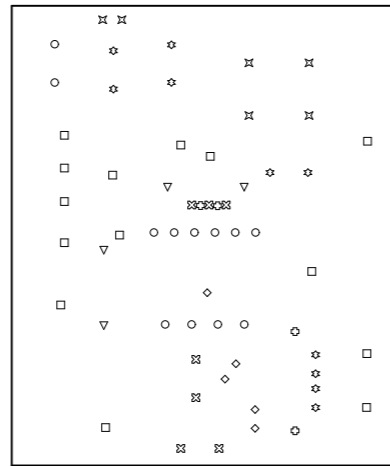
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 2/2/2015 3:35:45 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/2/2015 3:35:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 2/2/2015 3:35:47 PM	TEXAS INSTRUMENTS	

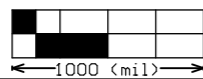
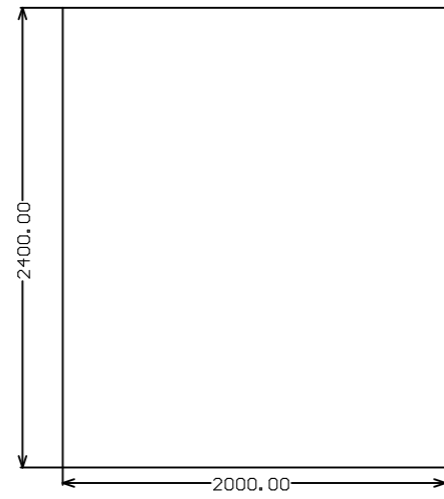


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
□	2	18mil (0.457mm)			PTH	Round
▽	2	32mil (0.813mm)			PTH	Round
◇	4	33mil (0.838mm)			PTH	Round
▽	2	33.465mil (0.85mm)			PTH	Round
☆	4	35mil (0.889mm)			PTH	Round
✕	2	35.433mil (0.9mm)			PTH	Round
☆	6	37.402mil (0.95mm)			PTH	Round
✕	4	38mil (0.965mm)			PTH	Round
✕	4	39.37mil (1mm)			PTH	Round
○	10	43.307mil (1.1mm)			PTH	Round
✕	3	45mil (1.143mm)			PTH	Round
○	2	51.181mil (1.3mm)			PTH	Round
□	12	63mil (1.6mm)			PTH	Round
◇	2	90.551mil (2.3mm)			PTH	Round
◇	2	21mil (0.533mm)	100mil (2.54mm)	79mil (2.007mm)	NPTH	Slot
◇	1	31mil (0.787mm)	1225mil (31.115mm)	1194mil (30.328mm)	NPTH	Slot
	62 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
 Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/2/2015	3:35:48 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9561	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/2/2015 3:35:49 PM	TEXAS INSTRUMENTS	

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